1 General description

The NX3L4051 is a low-ohmic 8-channel analog switch, suitable for use as an analog or digital multiplexer/demultiplexer. The NX3L4051 has three digital select inputs (S1 to S3), eight independent inputs/outputs (Y0 to Y7) and a common input/output (Z). All eight switches share an enable input (\overline{E}). A HIGH on \overline{E} causes all switches into the high impedance OFF-state, independent of Sn.

Schmitt trigger action at the digital inputs makes the circuit tolerant to slower input rise and fall times. Low threshold digital inputs allows this device to be driven by 1.8 V logic levels in 3.3 V applications without significant increase in supply current I_{CC}. This makes it possible for the NX3L4051 to switch 4.3 V signals with a 1.8 V digital controller, eliminating the need for logic level translation.The NX3L4051 allows signals with amplitude up to V_{CC} to be transmitted from Z to Yn or from Yn to Z. Its low ON resistance (0.5 Ω) and flatness (0.13 Ω) ensures minimal attenuation and distortion of transmitted signals.

2 Features and benefits

- Wide supply voltage range from 1.4 V to 4.3 V
- Very low ON resistance (peak):
 - 1.7 Ω (typical) at V_{CC} = 1.4 V
 - 1.0 Ω (typical) at V_{CC} = 1.65 V
 - 0.6 Ω (typical) at V_{CC} = 2.3 V
 - 0.5 Ω (typical) at V_{CC} = 2.7 V
 - 0.5 Ω (typical) at V_{CC} = 4.3 V
- Break-before-make switching
- High noise immunity
- ESD protection:
 - HBM JESD22-A114F Class 3A exceeds 7500 V
 - MM JESD22-A115-A exceeds 200 V
 - CDM AEC-Q100-011 revision B exceeds 1000 V
 - IEC61000-4-2 contact discharge exceeds 8000 V for switch ports
- CMOS low-power consumption
- Latch-up performance exceeds 100 mA per JESD 78B Class II Level A
- 1.8 V control logic at V_{CC} = 3.6 V
- · Control input accepts voltages above supply voltage
- Very low supply current, even when input is below V_{CC}
- High current handling capability (350 mA continuous current under 3.3 V supply)
- Specified from -40 °C to +85 °C and from -40 °C to +125 °C



3 Applications

- Cell phone
- PDA
- Portable media player
- Analog multiplexing and demultiplexing
- Digital multiplexing and demultiplexing
- Signal gating

4 Ordering information

Table 1. Ordering information

Type number	Topside mark	Package			
		Temperature range	Name	Description	Version
NX3L4051HR	M41	-40 °C to +125 °C	HXQFN16	plastic thermal enhanced extremely thin quad flat package; no leads; 16 terminals; body 3 × 3 × 0.5 mm	SOT1039-2
NX3L4051PW	X3L4051	-40 °C to +125 °C	TSSOP16	plastic thin shrink small outline package; 16 leads; body width 4.4 mm	SOT403-1

4.1 Ordering options

Table 2. Ordering options

Type number	Orderable part number	Package	Packing method	Minimum order quantity	Temperature
NX3L4051HR	NX3L4051HRZ	HXQFN16	REEL 7" Q1 NDP SSB	1500	T _{amb} = -40 °C to 125 °C
NX3L4051PW	NX3L4051PW,118	TSSOP16	REEL 13" Q1 NDP	2500	T _{amb} = -40 °C to 125 °C

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5 Functional diagram



6 Pinning information

6.1 Pinning



6.2 Pin description

Table 3. Pin description

Symbol	Pin	Pin				
	SOT1039-2	SOT403-1	-			
Y0, Y1, Y2, Y3, Y4, Y5, Y6, Y7	11, 12, 13, 10, 15, 3, 16, 2	13, 14, 15, 12, 1, 5, 2, 4	independent input or output			
Z	1	3	independent output or input			
Ē	4	6	enable input (active LOW)			
n.c.	5	7	not connected			
GND	6	8	ground (0 V)			
S1, S2, S3	9, 8, 7	11, 10, 9	select input			
V _{CC}	14	16	supply voltage			

7 Functional description

Table 4. Function table	e ^[1]			
Input				Channel ON
Ē	S3	S2	S1	
L	L	L	L	Y0 = Z
L	L	L	Н	Y1 = Z
L	L	Н	L	Y2 = Z
L	L	Н	Н	Y3 = Z
L	Н	L	L	Y4 = Z
L	Н	L	Н	Y5 = Z

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Input	Channel ON			
E	S3	S2	S1	
L	Н	Н	L	Y6 = Z
L	Н	Н	Н	Y7 = Z
Н	Х	Х	Х	switches off

[1] H = HIGH voltage level; L = LOW voltage level; X = don't care.

Limiting values 8

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions		Min	Max	Unit
V _{CC}	supply voltage			-0.5	+4.6	V
VI	input voltage	Sn and E	[1]	-0.5	+4.6	V
V _{SW}	switch voltage		[2]	-0.5	V _{CC} + 0.5	V
I _{IK}	input clamping current	V _I < -0.5 V		-50	-	mA
I _{SK}	switch clamping current	V_{I} < -0.5 V or V_{I} > V_{CC} + 0.5 V		-	±50	mA
I _{SW}	switch current	$\rm V_{SW}$ > -0.5 V or $\rm V_{SW}$ < $\rm V_{CC}$ + 0.5 V; source or sink current		-	±350	mA
		V_{SW} > -0.5 V or V_{SW} < V_{CC} + 0.5 V; pulsed at 1 ms duration, < 10 % duty cycle; peak current		-	±500	mA
T _{stg}	storage temperature			-65	+150	°C
P _{tot}	total power dissipation	T _{amb} = -40 °C to +125 °C				
		HXQFN16	[3]	-	250	mW
		TSSOP16	[4]	-	500	mW

The minimum input voltage rating may be exceeded if the input current rating is observed. The minimum and maximum switch voltage ratings may be exceeded if the switch clamping current rating is observed but may not exceed 4.6 V. For HXQFN16 package: above 135 °C the value of P_{tot} derates linearly with 16.9 mW/K. For TSSOP16 package: above 60 °C the value of P_{tot} derates linearly with 5.5 mW/K above.

[1] [2] [3] [4]

Recommended operating conditions 9

Table 6. Recommended operating conditions

Symbol	Parameter	Conditions		Min	Max	Unit
V _{CC}	supply voltage			1.4	4.3	V
VI	input voltage	Sn and E		0	4.3	V
V _{SW}	switch voltage		[1]	0	V _{CC}	V
T _{amb}	ambient temperature			-40	+125	°C
Δt/ΔV	input transition rise and fall rate	Sn and \overline{E} ; V _{CC} = 1.4 V to 4.3 V		-	200	ns/V

[1] To avoid sinking GND current from terminal Z when switch current flows in terminal Yn, the voltage drop across the bidirectional switch must not exceed 0.4 V. If the switch current flows into terminal Z, no GND current will flow from terminal Yn. In this case, there is no limit for the voltage drop across the switch.

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10 Static characteristics

Table 7. Static characteristics

At recommended operating conditions; voltages are referenced to GND (ground 0 V).

Symbol	Parameter	Conditions	Ta	amb = 25	°C	T _{amb} = -40 °C to +125 °C			
			Min	Тур	Мах	Min	Max (85 °C)	Max (125 °C)	-
VIH	HIGH-level	V _{CC} = 1.4 V to 1.6 V	0.9	-	-	0.9	-	-	V
	input voltage	V _{CC} = 1.65 V to 1.95 V	0.9	-	-	0.9	-	-	V
		V _{CC} = 2.3 V to 2.7 V	1.1	-	-	1.1	-	-	V
		V _{CC} = 2.7 V to 3.6 V	1.3	-	-	1.3	-	-	V
		V _{CC} = 3.6 V to 4.3 V	1.4	-	-	1.4	-	-	V
VIL	LOW-level	V _{CC} = 1.4 V to 1.6 V	-	-	0.3	-	0.3	0.3	V
	input voltage	V _{CC} = 1.65 V to 1.95 V	-	-	0.4	-	0.4	0.3	V
		V _{CC} = 2.3 V to 2.7 V	-	-	0.4	-	0.4	0.4	V
		V _{CC} = 2.7 V to 3.6 V	-	-	0.5	-	0.5	0.5	V
		V _{CC} = 3.6 V to 4.3 V	-	-	0.6	-	0.6	0.6	V
I _I	input leakage current	Sn and Ē; V _I = GND to 4.3 V; V _{CC} = 1.4 V to 4.3 V	-	-	-	-	±0.5	±1	μA
I _{S(OFF)}	OFF-state	Yn ports; see <u>Figure 5</u>							
	leakage current	V _{CC} = 1.4 V to 3.6 V	-	-	±5	-	±50	±500	nA
	ourront	V _{CC} = 3.6 V to 4.3 V	-	-	±10	-	±50	±500	nA
I _{S(ON)}	ON-state leakage	Z port; V _{CC} = 1.4 V to 3.6 V; see <u>Figure 6</u>							
	current	V _{CC} = 1.4 V to 3.6 V	-	-	±20	-	±200	±2000	nA
		V _{CC} = 3.6 V to 4.3 V	-	-	±40	-	±200	±2000	nA
I _{CC}	supply current	$V_1 = V_{CC}$ or GND; $V_{SW} =$ GND or V_{CC}							
		V _{CC} = 3.6 V	-	-	100	-	500	5000	nA
		V _{CC} = 4.3 V	-	-	150	-	800	6000	nA
ΔI _{CC}	additional	V_{SW} = GND or V_{CC}							
	supply current	V _I = 2.6 V; V _{CC} = 4.3 V	-	2.0	4.0	-	7	7	μA
		V _I = 2.6 V; V _{CC} = 3.6 V	-	0.35	0.7	-	1	1	μA
		V _I = 1.8 V; V _{CC} = 4.3 V	-	7.0	10.0	-	15	15	μA
		V _I = 1.8 V; V _{CC} = 3.6 V	-	2.5	4.0	-	5	5	μA
		V _I = 1.8 V; V _{CC} = 2.5 V	-	50	200	-	300	500	nA
CI	input capacitance	Sn and E	-	1.0	-	-	-	-	pF
$C_{S(OFF)}$	OFF-state capacitance		-	35	-	-	-	-	pF

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Symbol	Parameter	Conditions		Tai	_{mb} = 25	°C	T _{amb} =	Unit		
				Min	Тур	Мах	Min	Max (85 °C)	Max (125 °C)	
C _{S(ON)}	ON-state capacitance			-	350	-	-	-	-	pF

10.1 Test circuits





10.2 ON resistance

Table 8. ON resistance^[1]

At recommended operating conditions; voltages are referenced to GND (ground = 0 V); for graphs see Figure 8 to Figure 14.

Symbol	Symbol Parameter Conditions		T _{amb} =	-40 °C to	o +85 ℃	T _{amb} = -40 °	Unit		
				Min	Typ ^[2]	Мах	Min	Мах	
R _{ON(peak)} ON re (peak	ON resistance (peak)	$V_I = GND$ to V_{CC} ; $I_{SW} = 100$ mA; see Figure 7							
		V _{CC} = 1.4 V		-	1.7	3.7	-	4.1	Ω
		V _{CC} = 1.65 V		-	1.0	1.6	-	1.7	Ω
		V _{CC} = 2.3 V		-	0.6	0.8	-	0.9	Ω
		V _{CC} = 2.7 V		-	0.5	0.75	-	0.9	Ω
		V _{CC} = 4.3 V		-	0.5	0.75	-	0.9	Ω

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Symbol	Parameter	Conditions		T _{amb} =	-40 °C to	o +85 °C	T _{amb} = -40 °	Unit	
				Min	Typ ^[2]	Мах	Min	Мах	
ΔR _{ON}	ON resistance mismatch	$V_I = GND$ to V_{CC} ; $I_{SW} = 100$ mA	[3]						
	between channels	V _{CC} = 1.4 V; V _{SW} = 0.4 V		-	0.18	0.30	-	0.30	Ω
		V _{CC} = 1.65 V; V _{SW} = 0.5 V		-	0.18	0.20	-	0.30	Ω
		V _{CC} = 2.3 V; V _{SW} = 0.7 V		-	0.07	0.10	-	0.13	Ω
		V _{CC} = 2.7 V; V _{SW} = 0.8 V		-	0.07	0.10	-	0.13	Ω
		V _{CC} = 4.3 V; V _{SW} = 0.8 V		-	0.07	0.10	-	0.13	Ω
R _{ON(flat)}	ON resistance (flatness)	$V_I = GND$ to V_{CC} ; $I_{SW} = 100$ mA	[4]						
		V _{CC} = 1.4 V		-	1.0	3.3	-	3.6	Ω
		V _{CC} = 1.65 V		-	0.5	1.2	-	1.3	Ω
		V _{CC} = 2.3 V		-	0.15	0.3	-	0.35	Ω
		V _{CC} = 2.7 V		-	0.13	0.3	-	0.35	Ω
		V _{CC} = 4.3 V		-	0.2	0.4	-	0.45	Ω

For NX3L4051PW (TSSOP16 package), all ON resistance values are up to 0.05 Ω higher.

[1] [2] [3] [4] Typical values are measured at $T_{amb} = 25$ °C. Measured at identical V_{CC}, temperature and input voltage. Flatness is defined as the difference between the maximum and minimum value of ON resistance measured at identical V_{CC} and temperature.

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10.3 ON resistance test circuit and graphs



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11 Dynamic characteristics

Table 9. Dynamic characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V); for load circuit see Figure 17.

Symbol	Parameter	Conditions		Ta	_{imb} = 25	°C	T _{amb} =	Unit		
					Typ ^[1]	Max	Min	Max (85 °C)	Max (125 °C)	
t _{en}	enable time	Ē, Sn to Z or Yn; see <u>Figure 15</u>								
		V _{CC} = 1.4 V to 1.6 V		-	45	100	-	120	125	ns
		V _{CC} = 1.65 V to 1.95 V		-	32	75	-	85	95	ns
		V_{CC} = 2.3 V to 2.7 V		-	21	50	-	55	60	ns
		V _{CC} = 2.7 V to 3.6 V		-	19	45	-	45	50	ns
		V_{CC} = 3.6 V to 4.3 V		-	19	45	-	45	50	ns
t _{dis}	disable time	Ē, Sn to Z or Yn; see <u>Figure 15</u>								
		V _{CC} = 1.4 V to 1.6 V		-	25	80	-	90	105	ns
		V _{CC} = 1.65 V to 1.95 V		-	15	65	-	70	75	ns
		V_{CC} = 2.3 V to 2.7 V		-	9	30	-	35	40	ns
		V _{CC} = 2.7 V to 3.6 V		-	8	25	-	30	35	ns
		V_{CC} = 3.6 V to 4.3 V		-	8	25	-	30	35	ns
t _{b-m}	break-before-make	see <u>Figure 16</u>	[2]							
	time	V _{CC} = 1.4 V to 1.6 V		-	19	-	9	-	-	ns
		V _{CC} = 1.65 V to 1.95 V		-	17	-	7	-	-	ns
		V_{CC} = 2.3 V to 2.7 V		-	12	-	4	-	-	ns
		V _{CC} = 2.7 V to 3.6 V		-	10	-	3	-	-	ns
		V_{CC} = 3.6 V to 4.3 V		-	9	-	2	-	-	ns

Typical values are measured at T_{amb} = 25 °C and V_{CC} = 1.5 V, 1.8 V, 2.5 V, 3.3 V and 4.3 V respectively. Break-before-make guaranteed by design. [1] [2]

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11.1 Waveform and test circuits



Table 10. Measurement points

Supply voltage	Input	Output
V _{cc}	V _M	V _X
1.4 V to 4.3 V	0.5V _{CC}	0.9V _{OH}



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Table 11. Test data

Supply voltage	Input		Load	
Vcc	VI	t _r , t _f	CL	RL
1.4 V to 4.3 V	V _{CC}	≤ 2.5 ns	35 pF	50 Ω

11.2 Additional dynamic characteristics

Table 12. Additional dynamic characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V); $V_I = GND$ or V_{CC} (unless otherwise specified); $t_r = t_f \le 2.5$ ns; $T_{amb} = 25$ °C.

Symbol	Parameter	Conditions		Min	Тур	Мах	Unit
THD	total harmonic	f_i = 20 Hz to 20 kHz; R_L = 32 Ω ; see Figure 18	[1]				
di	distortion	V _{CC} = 1.4 V; V _I = 1 V (p-p)		-	0.15	-	%
		V _{CC} = 1.65 V; V _I = 1.2 V (p-p)		-	0.10	-	%
		V _{CC} = 2.3 V; V _I = 1.5 V (p-p)		-	0.02	-	%
		V _{CC} = 2.7 V; V _I = 2 V (p-p)		-	0.02	-	%
		V _{CC} = 4.3 V; V _I = 2 V (p-p)		-	0.02	-	%
f _(-3dB) -3 dB freq	-3 dB frequency	R_L = 50 Ω; see Figure 19	[1]				
	response	V _{CC} = 1.4 V to 4.3 V		-	15	-	MHz
α_{iso}	isolation (OFF-state)	f_i = 100 kHz; R_L = 50 Ω ; see <u>Figure 20</u>	[1]				
		V _{CC} = 1.4 V to 4.3 V		-	-90	-	dB
V _{ct}	crosstalk voltage	between digital inputs and switch; $f_i = 1$ MHz; $C_L = 50$ pF; $R_L = 50$ Ω ; see Figure 21					
		V _{CC} = 1.4 V to 3.6 V		-	0.2	-	V
		V _{CC} = 3.6 V to 4.3 V		-	0.3	-	V
Xtalk	crosstalk	between switches; f_i = 100 kHz; R_L = 50 Ω ; see Figure 22	[1]				

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Symbol	Parameter	Conditions	Min	Тур	Max	Unit
		V _{CC} = 1.4 V to 4.3 V	-	-90	-	dB
Q _{inj} charge injection	charge injection	f _i = 1 MHz; C _L = 0.1 nF; R _L = 1 MΩ; V _{gen} = 0 V; R _{gen} = 0 Ω; see Figure 23				
		V _{CC} = 1.5 V	-	3	-	рС
		V _{CC} = 1.8 V	-	4	-	рС
		V _{CC} = 2.5 V	-	6	-	рС
		V _{CC} = 3.3 V	-	9	-	рС
		V _{CC} = 4.3 V	-	15	-	рС

[1] f_i is biased at 0.5V_{CC}.

11.3 Test circuits



Figure 18. Test circuit for measuring total harmonic distortion



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12 Package outline



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13 Abbreviations

Table 13. Abbreviations				
Acronym	Description			
CDM	Charged Device Model			
CMOS	Complementary Metal-Oxide Semiconductor			
ESD	ElectroStatic Discharge			
НВМ	Human Body Model			
MM	Machine Model			
PDA	Personal Digital Assistant			

14 Revision history

Table 14. Revision histo	ory			
Document ID	Release date	Data sheet status	Change notice	Supersedes
NX3L4051 v.5.1	20200930	Product data sheet	-	NX3L4051 v.5
Modifications:	• <u>Section 4</u> : Addee	d <u>Section 4.1;</u> NX3L4051HR,1	15 replaced with NX3I	L4051HRZ
NX3L4051 v.5	20120703	Product data sheet	-	NX3L4051 v.4
Modifications:	For type number	NX3L4051HR the sot code h	as changed to SOT10	39-2.
NX3L4051 v.4	20111107	Product data sheet	-	NX3L4051 v.3
Modifications:	 Legal pages upo 	lated.		,
NX3L4051 v.3	20101222	Product data sheet	-	NX3L4051 v.2
NX3L4051 v.2	20100812	Product data sheet	-	NX3L4051 v.1
NX3L4051 v.1	20100415	Product data sheet	-	-

15 Legal information

15.1 Data sheet status

Document status ^{[1][2]}	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

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